



To directly access the Flash, software should follow these steps:

1. Write a 1b to the *Flash Request* bit (FLA.FL_REQ).
2. Read the *Flash Grant* bit (FLA.FL_GNT) until it becomes 1b. It remains 0b as long as there are other accesses to the Flash.
3. Write or read the Flash using the direct access to the 4-wire interface as defined in the FLA register. The exact protocol used depends on the Flash placed on the board and can be found in the appropriate Flash datasheet.
4. Write a 0b to the *Flash Request* bit (FLA.FL_REQ).

3.5.2 Flash Write Control

The Flash is write controlled by the bits in the EEPROM/FLASH Control and Data (EEC.FWE) register. Note that attempts to write to the Flash device when writes are disable (FWE=01b) should not be attempted. Behavior after such an operation is undefined, and might result in component and/or system hangs.

After sending one byte to write to the Flash, software can check if it can send the next byte to write (check if the write process in the Flash had finished) by reading the FLA register. If bit (FLA.FL_BUSY) in this register is set, the current write did not finish. If bit (FLA.FL_BUSY) is cleared, then software can continue and write the next byte to the Flash.

3.5.3 Flash Erase Control

When software needs to erase the Flash it should set the FLA.FL_ER bit in the FLA register to 1b (Flash erase and set bits EEC.FWE in the EEPROM/Flash Control register to 0b).

Hardware gets this command and sends the Erase command to the Flash. The erase process then finishes by itself. Software should wait for the end of the erase process before any further access to the Flash. This can be checked by using the Flash Write control mechanism previously described (see [Section 3.5.2](#)).

The opcode used for the erase operation is defined in the FLOP register.

Note: Sector erase by software is not supported. To delete a sector, the serial (bit bang) interface should be used.

3.5.4 Flash Access Contention

The 82599 implements internal arbitration between Flash accesses initiated through the LAN 0 device and those initiated through the LAN 1 device. If accesses from both LAN devices are initiated during the same approximate size window, The first one is served first and only then the next one. Note that the 82599 does not synchronize between the two entities accessing the Flash though contentions caused from one entity reading and the other modifying the same locations is possible.



To avoid this contention, accesses from both LAN devices should be synchronized using external software synchronization of the memory or I/O transactions responsible for the access. It is possible to ensure contention-avoidance simply by the nature of the software sequence.

3.6 Configurable I/O Pins — Software-Definable Pins (SDP)

The 82599 has eight Software-Defined Pins (SDP pins) per port that can be used for miscellaneous hardware or software-controllable purposes (see [Figure 3-11](#)). These pins and their function are bound to a specific LAN device. The use, direction, and values of SDP pins are controlled and accessed by the Extended SDP Control (ESDP) register. To avoid signal contention, following power up, all eight pins are defined as input pins.

Some SDP pins have specific functionality:

- The default direction of the lower SDP pins (SDP0-SDP3) is loaded from the SDP Control word in the EEPROM.
- The lower SDP pins (SDP0-SDP3) can also be configured for use as external interrupt sources (GPI). To act as GPI pins, the desired pins must be configured as inputs and enabled by the GPIE register. When enabled, an interrupt is asserted following a rising-edge detection of the input pin (rising-edge detection occurs by comparing values sampled at the internal clock rate, as opposed to an edge-detection circuit). When detected, a corresponding GPI interrupt is indicated in the EICR register.

Certain SDP pins can be allocated to hardware functions. For example SDP2, SDP3, SDP6 and SDP7 can be defined to support IEEE1588 auxiliary devices. In addition, the functionality of the I/O pins are programmed by the TimeSync Auxiliary Control (TSAUXC) register.

[Table 3-13](#) defines an **example** of possible usage of SDP I/O pins, MDIO pins, and I²C pins as a function of an optical module or the PHY being interfaced. If mapping of these SDP pins to a specific hardware function is not required then the pins can be used as general purpose software defined I/Os. For any of the function specific usages, the SDP I/O pins should be set to native mode by software by setting the *SDPxxx_NATIVE* bits in the ESDP register. Native mode in those SDP I/O pins designed for PHY and optical module specific usages, defines the pin functionality while in an inactive state (reset or power down) while behavior in an active state is controlled by software. The hardware functionality of these SDP I/O pins differ mainly by the active behavior controlled by software.

Table 3-13 Example for SDP, MDIO and I²C Ports Usage

	SFP+	Reserved	Copper PHY	X2/XPAK ¹
SDP0	GPIO: RX_LOS		GPIO: INTR_L	GPIO: LASI
SDP1	GPIO: RX_LOS_N			
SDP2	GPIO: MOD_ABS_N			
SDP3	GPIO: TX_DISABLE		NATIVE: TS_SDP3	NATIVE: TS_SDP3
SDP4 Port 0	IN: SEC_ENA		IN: SEC_ENA	IN: SEC_ENA

**Table 3-13 Example for SDP, MDIO and I²C Ports Usage (Continued)**

	SFP+	Reserved	Copper PHY	X2/XPAK ¹
SDP4 Port 1	GPIO		GPIO	GPIO
SDP5	NATIVE: RS0/RS1 drive		NATIVE: RESET	NATIVE: TX ON/OFF ²
SDP6	GPIO: RS0/RS1 sense		NATIVE: TS_SDP6	GPIO: RESET_N
SDP7	GPIO: TX_FAULT		NATIVE: TS_SDP7	NATIVE: TS_SDP7
MDIO			MDIO	MDIO
I ² C	I ² C			

1. To Support XENPAK, X2 or XPAK modules, 3.3V to 1.2V level shifters are required between the 82599 and an optical module.
2. When TX ON/OFF is low in XENPAK, X2 and XPAK modules transmission is disabled. The *SDP5_Function* bit in the ESDP register should be set to 0b enabling the pin to be at a HiZ state while the 82599 is in an inactive state (as defined in the register). Board designers should populate with an external pull-down resistor forcing a low level during an inactive state.

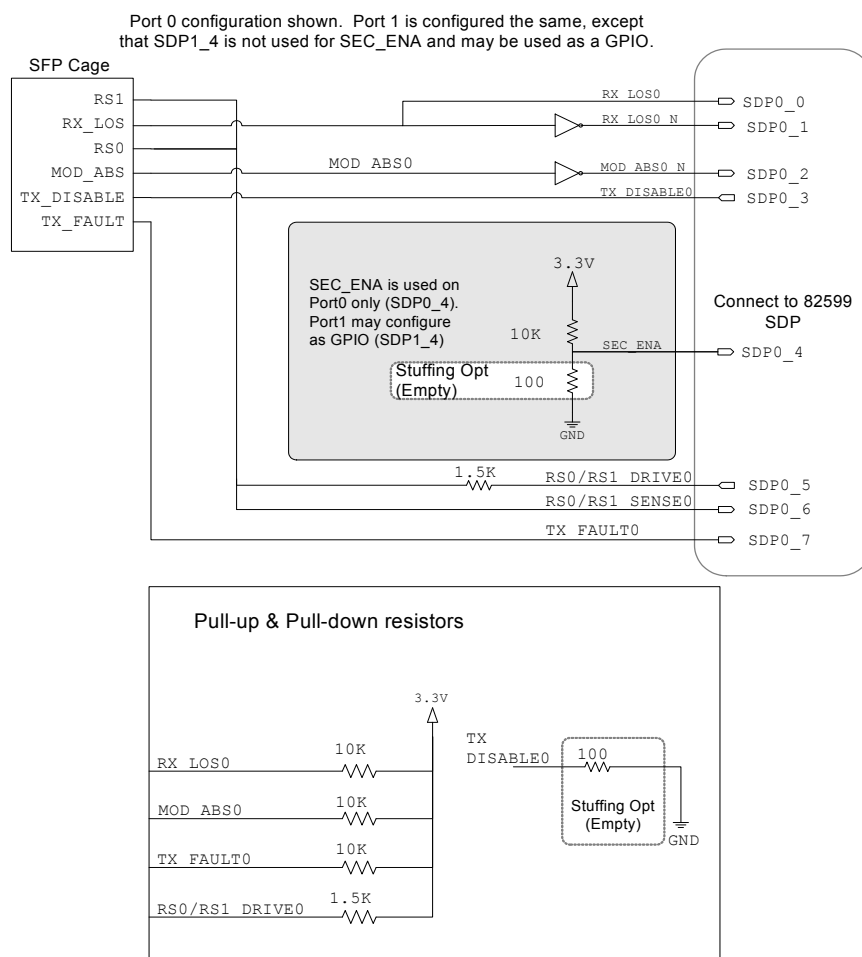
**Figure 3-11 SDP Connections**



Table 3-14 lists the signals defined in Table 3-13 and behavior during reset and power down state (D3) without management.

Table 3-14 SDP Assigned Signals Description

Signal	Description	Software I/O Programming	Default Values at (Reset, D3 no WoL and no MNG)
RX_LOS, RX_LOS_N	RX_LOS high and RX_LOS_N low indicate insufficient optical power for reliable signal reception.	GPIO: Input	Input, no change.
LASI, INTR_L	INTR_L or Link Alarm Status Interrupt (LASI) — when low, indicates possible module operational fault or a status critical to the host system.	GPIO: Input (Interrupt)	Input, no change.
RS0/RS1 drive	Short-circuit protected.	Native: Output	Output, autonomous high or tri-state with pull-up.
RS0/RS1 sense	Directly connected input.	GPIO: Input	Input, no change.
P_DOWN/RST	When held high by the host, places the module in standby (low power) mode. The negative edge of P_DOWN/RST signal initiates a complete module reset.	GPIO: Output	Input, no change. In order to minimize PHY power, software should drive the SDP to high or set to input while populating a pull-up.
RESET_N	When low, XENPAK, X2 or XPAK optical module is reset.	GPIO: Output	Output, no change. In order to minimize PHY power software should drive the SDP to low or set to input while populating a pull-down.
RESET	When high, the copper PHY is reset.	Native: Output	Output, autonomous high or tri-state with pull-up.
TX_DISABLE	When TX_DISABLE is asserted high, optical module transmitter is turned off.	GPIO: Output	Output, no change. In order to minimize PHY power software should drive the SDP to high or set to input while populating a pull-up.
TX_DIS	When TX_DIS is asserted high, optical module transmitter is turned off.	Native: Output	Output, autonomous high or tri-state with pull-up.
TX ON/OFF	1b = Transmitter on. 0b = Transmitter off.	Native: Output	Output, autonomous low or tri-state with pull-down.
MOD_DET_N	Inverted mode detect.	GPIO: Input (Interrupt)	Input, no change.
TS_SDPX	Time sync support pins, can be used as event in or event out.	Native: According to programmed functionality	Tri-state during reset. No change in D3. External pull-up / pull-down as required by the system designer.
TX_FAULT	When high, indicates that the module transmitter has detected a fault condition related to laser operation or safety.	GPIO: Input (Interrupt)	Input, no change.
MOD_NR	When high, indicates that the module has detected a condition that renders transmitter and or receiver data invalid.	GPIO: Input (Interrupt)	Input, no change.
MOD_ABS		GPIO: Input (Interrupt)	Input, no change.
FAN_Status	Optional health indication of the fan.	GPIO: Input (Interrupt)	Input, no change.



3.7 Network Interface (MAUI Interface)

The 82599 supports 10 GbE operation, 1 GbE operation and 100 Mb/s Ethernet operation on the MAUI interface. The 82599 can support different or the same link speeds (10 Gb/s, 1 Gb/s and 100 Mb/s) and protocols on each of the two MAUI ports. The 82599 also supports automatic crossover and polarity correction on each of the MAUI ports to eliminate the need for crossover cables between similar devices. The 82599 also supports auto-negotiation when configured for backplane Ethernet to automatically select between KX, KX4 and KR.

When in 10 GbE operating mode, the MAUI interface can be configured as any of the following:

- A four lane XAUI interface.
- A four lane 10GBASE-BX4 interface.
- A four lane 10GBASE-KX4 interface.
- A four lane 10GBASE-CX4 interface.
- A single lane 10GBASE-KR interface.
- A single lane SFI interface.

When in 1 GbE operating mode, the MAUI interface can be configured as any of the following:

- A single lane 1000BASE-KX interface.
- A single lane 1000BASE-BX interface.
- A single SGMII (1 Gb/s or 100 Mb/s) lane over a KX or BX compliant electrical interface.

The device implements all features required for transmission and reception defined for the XAUI, BX4, CX4, KX4, KX, KR, SFI and BX Media interface. The MAUI interface supports the IEEE 802.3ae

(10 GbE — XAUI), IEEE 802.3ap (KX, KX4 and KR), IEEE802.3ak (10GBASE-CX4), PICMG3.1 (1000BASE-BX and 10GBASE-BX4), and SFI standards.

In 10 GbE BX4, KX4, CX4 or XAUI operating modes, data passes on all four MAUI lanes complying with the BX4, KX4, CX4 or XAUI protocol. In 10GBASE-KR, SFI, SGMII, 1000BASE-KX, 1000BASE-BX, or 10GBASE-BX4 operation, data passes on MAUI lane 0 complying with the 10 GbE KR, SFI protocols, the 1 GbE KX or BX protocols or the 100 Mb/s and 1 GbE SGMII protocol over a KX or BX electrical interface.



3.7.1 10 GbE Interface

The 82599 provides complete functionality to support up to two 10 Gb/s ports. The device performs all functions required for transmission and reception defined in the various standards.

A lower-layer PHY interface is included to attach either to an external PMA or Physical Medium Dependent (PMD) components.

The 82599 enables 10 GbE operation compliant to the XAUI, CX4, KX4, KR, SFI specifications by programming the appropriate bits in the AUTOC register.

3.7.1.1 XAUI Operating Mode

The Ten Gigabit Attachment Unit Interface (XAUI) supports data rates of 10 Gb/s over four differential paths in each direction for a total of eight pairs, with each path operating at 3.125 Gb/s. The interface is used to connect the 82599 to an external 10 GbE PHY device with a XAUI interface. XAUI operating mode can be forced by software by setting the relevant bits in the AUTOC register and disabling auto-negotiation (see [Section 3.7.4.2](#)).

3.7.1.1.1 XAUI Overview

XAUI is a full-duplex interface that uses four self-clocked serial differential links in each direction to achieve 10 Gb/s data throughput. Each serial link operates at 3.125 GBaud to accommodate both data and the overhead associated with 8B/10B coding. The self-clocked nature eliminates skew concerns between clock and data, and enables a functional reach of up to 50 cm. Conversion between the XGMII and XAUI interfaces occurs at the XGXS (XAUI Extender Sublayer). Functional and electrical specifications of XAUI interface can be found in IEEE802.3 clause 47.

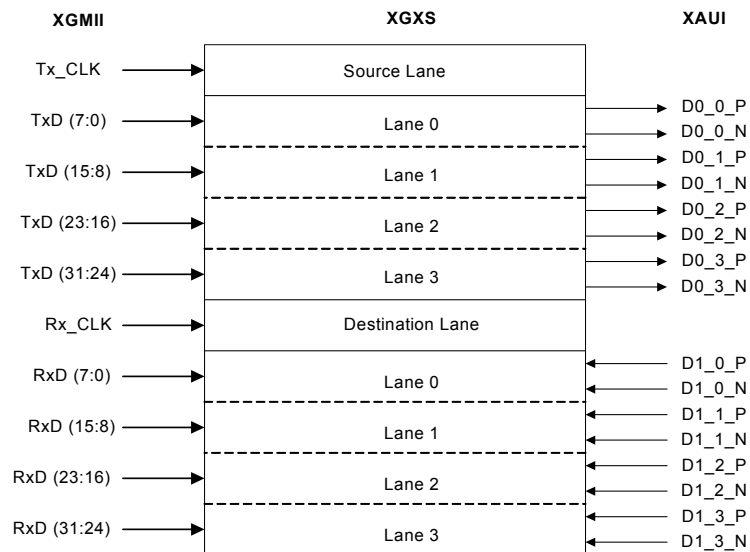


Figure 3-12 XGMII to XAUI at the XGXS

The XAUI interface has the following characteristics:

- Simple signal mapping to the XGMII.
- Independent transmit and receive data paths.
- Four lanes conveying the XGMII 32-bit data and control.
- Differential signaling with low voltage swing.
- Self-timed interface enables jitter control to the PCS.
- Using 8B/10B coding.

Figure 3-13 shows the architectural positioning of XAUI.

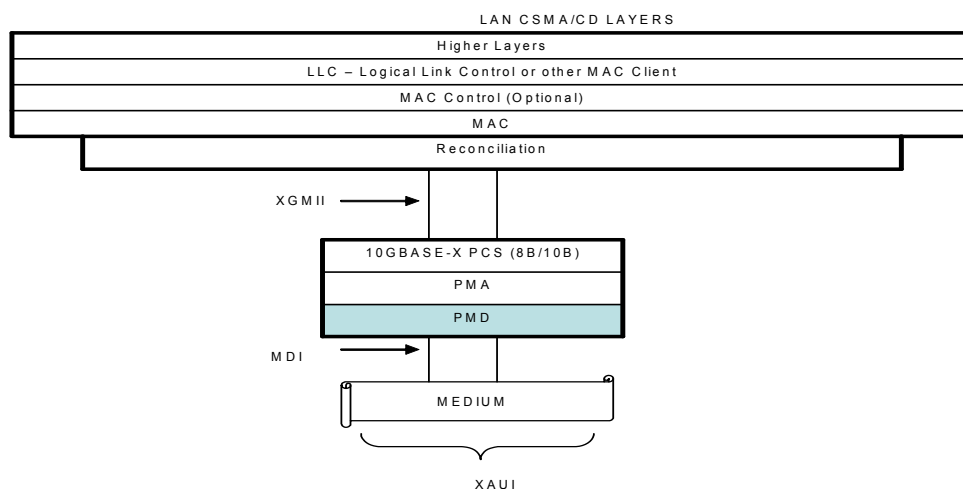


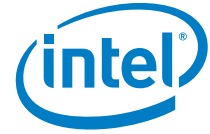
Figure 3-13 Architectural Positioning of XAUI

3.7.1.1.2 XAUI Operation

XAUI supports the 10 Gb/s data rate of the XGMII. The 10 Gb/s MAC data stream is converted into four lanes at the XGMII interface. The byte stream of each lane is 8B/10B encoded by the XGXS for transmission across the XAUI at a nominal rate of 3.125 GBaud. The XGXS and XAUI at both sides of the connection (MAC or PHY) can operate on independent clocks.

The following is a list of the major concepts of XGXS and XAUI:

1. The XGMII is organized into four lanes with each lane conveying a data octet or control character on each edge of the associated clock. The source XGXS converts bytes on an XGMII lane into a self clocked, serial, 8B/10B encoded data stream. Each of the four XGMII lanes is transmitted across one of the four XAUI lanes.
2. The source XGXS converts XGMII Idle control characters (inter-frame) into an 8B/10B code sequence.
3. The destination XGXS recovers clock and data from each XAUI lane and de-skews the four XAUI lanes into the single-clock XGMII.
4. The destination XGXS adds to or deletes from the inter-frame gap as needed for clock rate disparity compensation prior to converting the inter-frame code sequence back into XGMII idle control characters.
5. The XGXS uses the same code and coding rules as the 10GBASE-X PCS and PMA specified in IEEE 802.3 Clause 48.



3.7.1.1.3 XAUI Electrical Characteristics

The XAUI lane is a low swing AC coupled differential interface using NRZ signaling. AC coupling allows for inter-operability between components operating at different supply voltages. Low swing differential signaling provides noise immunity and reduced Electromagnetic Interference (EMI). Differential signal swings specifications depend on several factors, such as transmitter pre-equalization and transmission line losses.

The XAUI signal paths are point-to-point connections. Each path corresponds to a XAUI lane and is comprised of two complementary signals making a balanced differential pair. There are four differential paths in each direction for a total of eight pairs, or 16 connections. The signal paths are intended to operate up to approximately 50 cm over controlled impedance traces on standard FR4 Printed Circuit Boards (PCBs).

3.7.1.2 10GBASE-KX4 Operating Mode

The KX4 interface supports data rates of 10 Gb/s over copper traces in improved FR4 PCBs. Data is transferred over four differential paths in each direction for a total of eight pairs, with each path operating at 3.125Gbaud to support overhead of 8B/10B coding. The interface is used to connect the 82599 to a KX4 switch port over the backplane or to an external 10 GbE PHY device with a KX4 interface.

The MAUI interface is configured as a KX4 interface while auto-negotiation to a KX4 link partner is detected. KX4 operation can also be forced by EEPROM or software by setting the relevant bits in the AUTOC register and disabling auto-negotiation (see [Section 3.7.4.2](#)).

3.7.1.2.1 KX4 Overview

10GBASE-KX4 definition is based on XAUI with 10GBASE-CX4 extensions and specifies 10 Gb/s operation over four differential paths in each direction for a total of eight pairs, or 16 connections. This system uses the 10GBASE-X PCS and PMA as defined in IEEE802.3 Clause 48 with amendments for auto-negotiation as specified in IEEE802.3ap. The 10GBASE-KX4 PMD is defined in IEEE802.3ap Clause 71.

KX4 is a full-duplex interface that uses four self-clocked serial differential links in each direction to achieve 10 Gb/s data throughput. Each serial link operates at 3.125 Gbaud to accommodate both data and the overhead associated with 8B/10B coding. The self-clocked nature eliminates skew concerns between clock and data, and enables a functional reach of up to one meter.

[Figure 3-14](#) shows the architectural positioning of 10GBASE-KX4.

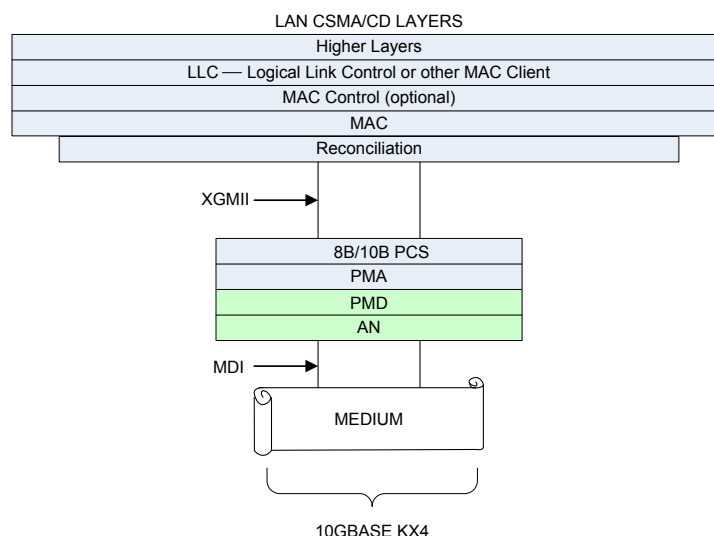


Figure 3-14 Architectural Positioning of 10GBASE-KX4

3.7.1.2.2 KX4 Electrical Characteristics

The KX4 lane is a low swing AC coupled differential interface using NRZ signaling. AC coupling allows for inter-operability between components operating at different supply voltages. Low swing differential signaling provides noise immunity and reduced EMI. Differential signal swings specifications depend on several factors, such as transmitter pre-equalization and transmission line losses.

The KX4 signal paths are point-to-point connections. Each path corresponds to a KX4 lane and is comprised of two complementary signals making a balanced differential pair. There are four differential paths in each direction for a total of eight pairs, or 16 connections. The signal paths are intended to operate up to approximately one meter over controlled impedance traces on improved FR4 PCBs.

3.7.1.3 10GBASE-KR Operating Mode

The KR interface supports data rates of 10 Gb/s over copper traces in improved FR4 PCBs. Data is transferred over a single differential path in each direction for a total of two pairs, with each path operating at $10.3125 \text{ Gbaud} \pm 100 \text{ ppm}$ to support overhead of 64B/66B coding. The interface is used to connect the 82599 to a KR switch port over the backplane.

The MAUI interface is configured as a KR interface while auto-negotiation to a KR link partner is detected. KR operation can also be forced by EEPROM or software by setting the relevant bits in the AUTOC register and disabling auto-negotiation (see [Section 3.7.4.2](#)). When in 10GBASE-KR operating mode, MAUI lane 0 is used for receive and transmit activity while lanes 1 to 3 of the MAUI interface are powered down.



3.7.1.3.1 KR Overview

10GBASE-KR definition enables 10 Gb/s operation over a single differential path in each direction for a total of two pairs, or four connections. This system uses the 10GBASE-KR PCS as defined in IEEE802.3 Clause 49 with amendments for auto-negotiation specified in IEEE802.3ap and 10 Gigabit PMA as defined in IEEE802.3 clause 51. The 10GBASE-KR PMD is defined in IEEE802.3ap Clause 72. The 10GBASE-KR PHY includes 10GBASE-KR Forward Error Correction (FEC), as defined in IEEE802.3ap Clause 74. FEC support is optional and is negotiated between Link partners during auto-negotiation as defined in IEEE802.3ap clause 73. Activating FEC improves link quality (2dB coding gain) by enabling correction of up to 11 bit-burst errors.

KR is a full-duplex interface that uses a single self-clocked serial differential link in each direction to achieve 10 Gb/s data throughput. The serial link transfers scrambled data at 10.3125 Gbaud to accommodate both data and the overhead associated with 64B/66B coding. The self-clocked nature eliminates skew concerns between clock and data, and enables a functional reach of up to one meter.

Following initialization and auto-negotiation 10GBASE-KR defines a start-up protocol, where link partners exchange continuous fixed length training frames using differential Manchester Encoding (DME) at a signaling rate equal to one quarter of the 10GBASE-KR signaling rate. This protocol facilitates timing recovery and receive equalization while also providing a mechanism through which the receiver can tune the transmit equalizer to optimize performance over the backplane interconnect. Successful completion of the start-up protocol enables transmission of data between the link partners.

Figure 3-15 shows the architectural positioning of 10GBASE-KR.

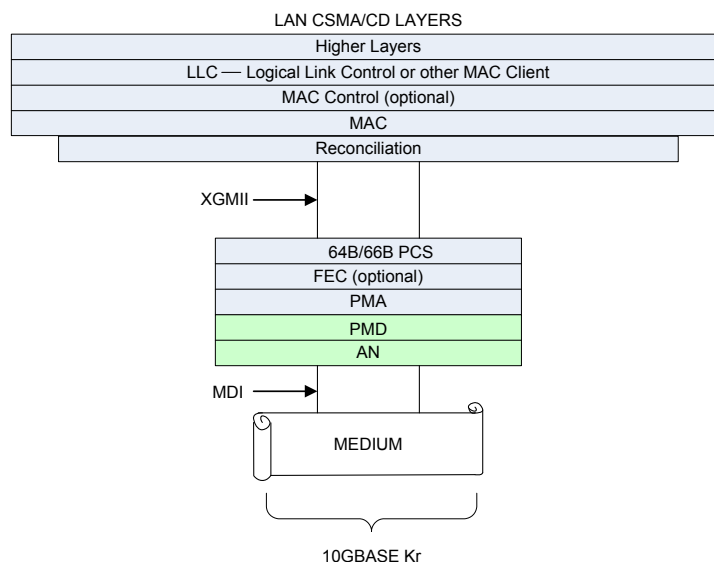


Figure 3-15 Architectural Positioning of 10GBASE-KR



3.7.1.3.2 KR Electrical Characteristics

The KR lane is a low swing AC coupled differential interface using NRZ signaling. AC coupling allows for inter-operability between components operating from at different supply voltages. Low swing differential signaling provides noise immunity and improved reduced EMI. Differential signal swings defined specifications depend on several factors, such as transmitter pre-equalization and transmission line losses.

The KR signal paths are point-to-point connections. Each path corresponds to a KR lane and is comprised of two complementary signals making a balanced differential pair. There is a single differential path in each direction for a total of two pairs, or four connections.

The 10GBASE-KR link requires a nominal 100 Ω differential source and load terminations with AC coupling on the receive side. The signal paths are intended to operate up to approximately one meter, including two connectors, over controlled impedance traces on improved FR4 PCBs.

3.7.1.3.3 KR Reverse Polarity

The 82599 supports reverse polarity of the KR transmit and receive lanes. It is enabled by the following EEPROM setting in the Core 0/1 Analog Configuration Modules:

Reverse Tx polarity setting:

EEPROM Word Offset (Starting at Odd Word)	Reserved	KR / SFI Reverse Polarity	Description
2*N+1		0x0101	Set page 1.
2*N+2		0x1E12	Write register 0x1E the data 0x12 to invert Tx polarity.

Reverse Rx polarity setting

EEPROM Word Offset (Starting at Odd Word)	Reserved	KR / SFI Reverse Polarity	Description
2*N+1		0x0101	Set page 1.
2*N+2		0x1FC0	Write register 0x1F the data 0xC0 to invert Rx polarity.

3.7.1.4 10GBASE-CX4 Operating Mode

The CX4 interface supports data rates of 10 Gb/s over twinaxial cable. Data is transferred over four differential paths in each direction for a total of eight pairs, with each path operating at 3.125Gbaud to support overhead of 8B/10B coding. The interface is used to connect the 82599 to a CX4 switch. CX4 operation can be forced by EEPROM or software by setting the relevant bits in the AUTOC register and disabling auto-negotiation (see [Section 3.7.4.2](#)).



3.7.1.4.1 CX4 Overview

10GBASE-CX4 definition specifies 10 Gb/s operation over four differential paths in each direction for a total of eight pairs, or 16 connections. This system uses the 10GBASE-X PCS and PMA as defined in IEEE802.3 Clause 48. The 10GBASE-CX4 PMD is defined in IEEE802.3 Clause 54.

CX4 is a full-duplex interface that uses four self-clocked serial differential links in each direction to achieve 10 Gb/s data throughput. Each serial link operates at 3.125 Gbaud to accommodate both data and the overhead associated with 8B/10B coding. The self-clocked nature eliminates skew concerns between clock and data.

Figure 3-16 shows the architectural positioning of 10GBASE-CX4.

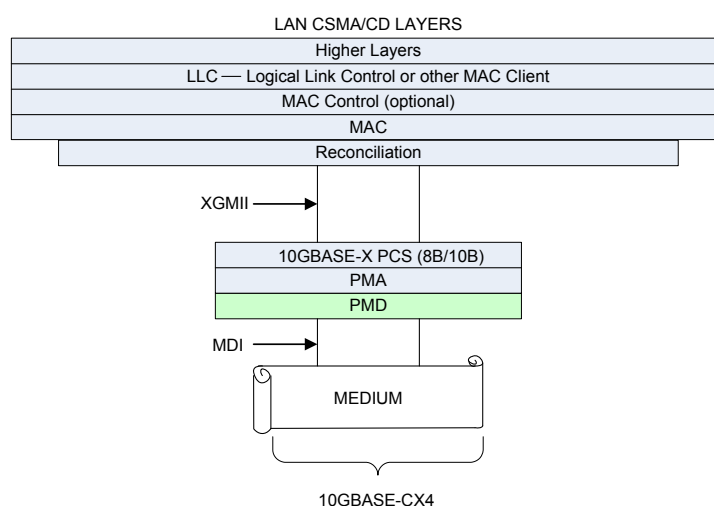


Figure 3-16 Architectural Positioning of 10GBASE-CX4

3.7.1.4.2 CX4 Electrical Characteristics

The CX4 lane is a low swing AC coupled differential interface using NRZ signaling. AC coupling allows for inter-operability between components operating from at different supply voltages. Low swing differential signaling provides noise immunity and improved reduced EMI. Differential signal swings defined specifications depend on several factors, such as transmitter pre-equalization and transmission line losses.

The CX4 signal paths are point-to-point connections. Each path corresponds to a CX4 lane and is comprised of two complementary signals making a balanced differential pair. There are four differential paths in each direction for a total of eight pairs, or 16 connections. The signal paths are intended to operate on twinaxial cable assemblies up to 15 m in length.



3.7.1.5 10GBASE-BX4 Operating Mode

10 GbE is supported within PICMG 3.1 by adopting a subset of the IEEE 802.3 XAUI specifications. Where XAUI is a chip-to-chip interface between test points TP-1 and TP-4, the PICMG 3.1 specifies what goes into the backplane at TP-T and what comes out of the backplane at TP-R. When implementing a 10 Gb/s PICMG 3.1 channel, board designers must implement this channel with compliant TP-T and TP-R test points.

Note: The channel-to-channel skew is handled by the XAUI protocol.

3.7.1.5.1 10GBASE-BX4 Electrical Characteristics

Transmitted Electrical Specifications at TP-1:

PICMG 3.1 specifies the compliance point TP-T. System designers are required to implement additional margin at TP-1 to ensure compliance at TP-T.

The impedance at termination must be $100\ \Omega \pm 10\%$.

Transmitted Electrical Specifications at TP-T:

The PICMG 3.1 drive levels into the backplane must conform to the following specifications as listed in [Table 3-15](#).

Table 3-15 Transmit Specifications at TP-T

Parameter	Value	Units
Baud rate	3.125	GBd
Clock tolerance	± 100	ppm
Differential amplitude maximum	1600	mV p-p
Absolute output voltage limits	-0.4 min, 1.6 max	V
Differential output return loss	See footnote ¹	dB
Output jitter		
Near-end maximums (TP-T)		
Total jitter	± 0.075 peak from the mean	UI
Deterministic jitter	± 0.085 peak from the mean	UI

1. $s_{11} = -10$ dB for $312.5\text{ MHz} < \text{Freq (f)} < 625\text{ MHz}$, and $-10 + 10\log(f/625)$ dB for $625\text{ MHz} \leq \text{Freq (f)} < 3.125\text{ GHz}$; where f is frequency in MHz.

Note: All measurements are made through a mated pair connector.

To maintain inter-operability between older and newer technologies and to avoid damage to the components, the maximum drive amplitude of any PICMG 3.1 driver must not exceed 1600 mV P-P.



The output impedance requirement applies to all valid output levels. The reference impedance for differential return loss measurements is 100 Ω .

Receiver Electrical Specifications at TP-R:

Table 3-16 lists the receiver specifications at TP-R.

Table 3-16 Receiver Specifications at TP-R

Parameter	Value	Units
Baud rate	3.125	GBd
Clock tolerance	± 100	ppm
Differential return loss	10	dB
Common mode return loss	6	dB
Jitter amplitude tolerance (p-p)	0.65	UI
Differential skew	75	ps

Receiver input impedance must result in a differential return loss better than 10 dB and a common mode return loss better than 6 dB from 100 MHz to 2.5 GHz. This includes contributions from all components related to the receiver including coupling components. The return loss reference impedance is 100 Ω for differential return loss and 25 Ω for common mode.

Receiver Electrical Specifications at TP-4:

PICMG 3.1 specifies the compliance point TP-R. System designers are required to ensure the additional losses to TP-4 are accounted for.

The AC coupling capacitors at the receiver must be no more than 470 pF +1% and matched within 2% with each other.

A 10GBASE-BX4 interface between two GbE ports is shown in Figure 3-17.

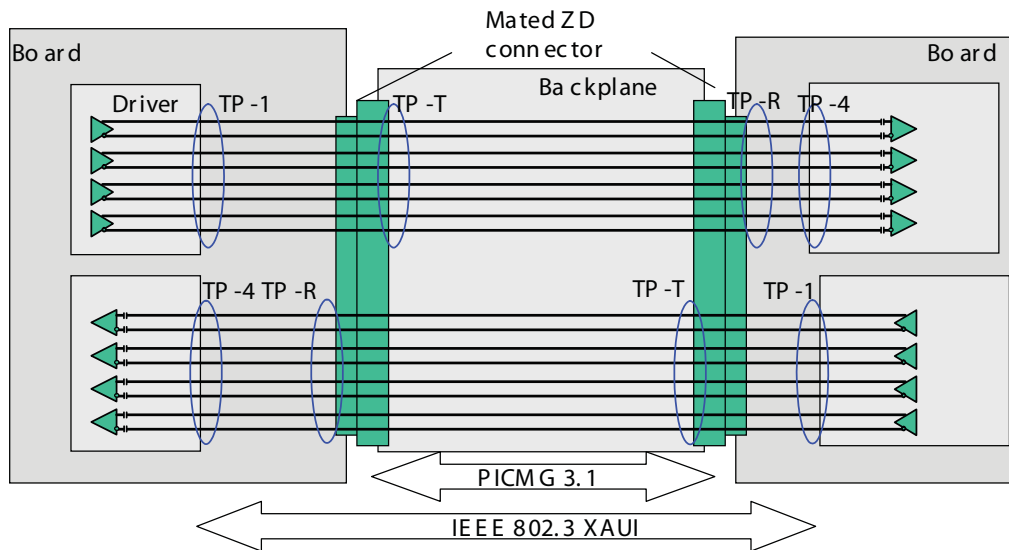


Figure 3-17 10GBASE-BX4 Electrical Environment

3.7.1.6 SFI Operating Mode

The MAUI interface is configured as SFI by EEPROM or software by setting the relevant bits in the AUTOC register and disabling auto-negotiation (see [Section 3.7.4.2](#)). When in SFI operating mode, only the operation of the 82599 Analog Front End (AFE) is modified, while the rest of the 82599 logic and circuitry operates similar to 10GBASE-KR. When in SFI operating mode, MAUI lane 0 is used for receive and transmit activity while lanes 1 to 3 of the MAUI interface are powered down.

3.7.1.6.1 SFI Overview

SFI definition enables 10 Gb/s operation over a single differential path in each direction for a total of two pairs, or four connections. When in SFI operating mode the 82599 uses the 10GBASE-R PCS and 10 Gigabit PMA as defined in IEEE802.3 Clause 49 and 51, respectively.

SFI is a full-duplex interface that uses a single self-clocked serial differential link in each direction to achieve 10 Gb/s data throughput. The serial link transfers scrambled data at 10.3125 Gbaud to accommodate both data and the overhead associated with 64B/66B coding. The self-clocked nature eliminates skew concerns between clock and data.



3.7.1.6.2 SFI Electrical Characteristics

The SFI lane is a low swing AC coupled differential interface using NRZ signaling. AC coupling allows for inter-operability between components operating from at different supply voltages. Low swing differential signaling provides noise immunity and improved reduced EM). Differential signal swings defined specifications depend on several factors, such as transmitter pre-equalization and transmission line losses.

The SFI signal paths are point-to-point connections. Each path corresponds to a SFI lane and is comprised of two complementary signals making a balanced differential pair. There is a single differential path in each direction for a total of two pairs, or four connections. The signal paths are intended to operate on FR4 PCBs.

SFI interface typically operates over 200 mm of improved FR4 material or up to about 150 mm of standard FR4 with one connector. The electrical interface is based on high speed low voltage AC coupled logic with a nominal differential impedance of 100 Ω . The SFI link requires nominal 100 Ω differential source and load terminations on both the host board and the module. The SFI terminations provide both differential and common mode termination to effectively absorb differential and common mode noise and reflections. All SFI transmitters and receivers are AC coupled. SFP+ modules incorporate blocking capacitors on all SFI lines.

3.7.2 GbE Interface

The 82599 provides complete support for up to two 1 Gb/s port implementations. The device performs all functions required for transmission and reception defined by the different standards.

A lower-layer PHY interface is included to attach either to external PMA or Physical Medium Dependent (PMD) components.

When operating in 1 GbE operation mode, the 82599 uses Lane 0 of the XAUI interface for 1 GbE operation while the other three XAUI lanes are powered down.

The 82599 enables 1 GbE operation compliant with the KX, BX or SGMII specifications by programming the appropriate bits in the AUTOC register.

3.7.2.1 1000BASE-KX Operating Mode

The MAUI interface, when operating as a KX Interface, supports data rates of 1 Gb/s over copper traces on improved FR4 PCBs. Data is transferred over a single differential path in each direction for a total of two pairs (Lane 0 of MAUI interface and Lanes 1 to 3 powered down), with each path operating at 1.25 Gbaud to support overhead of 8B/10B coding. The interface is used to connect the 82599 to a KX compliant switch port over the backplane or to KX compliant 1 GbE PHY device. In the event of auto-negotiation defined in IEEE802.3ap clause 73 ending with 1 Gb/s as the HCD, the MAUI interface is configured as a KX interface. KX operating mode can also be forced by software by setting the relevant bits in the AUTOC register and disabling auto-negotiation (see [Section 3.7.4.2](#)).

3.7.2.1.1 KX Overview

1000BASE-KX extends the family of 1000BASE-X Physical Layer signaling systems. KX specifies operation at 1 Gb/s over two differential, controlled impedance pairs of traces (one pair for transmit, one pair for receive). This system uses the 1000BASE-X PCS and PMA as defined in IEEE802.3 Clause 36 together with the amendments placed in IEEE802.3ap. The 1000BASE-KX PMD is defined in IEEE802.3ap Clause 70.

KX is a full-duplex interface that uses a single serial differential link in each direction to achieve 1 Gb/s data throughput. Each serial link operates at 1.25 GBaud to accommodate both data and the overhead associated with 8B/10B coding. The self-clocked nature eliminates skew concerns between clock and data, and enables a functional reach of up to one meter.

Figure 3-18 shows the architecture positioning of 1000BASE-KX.

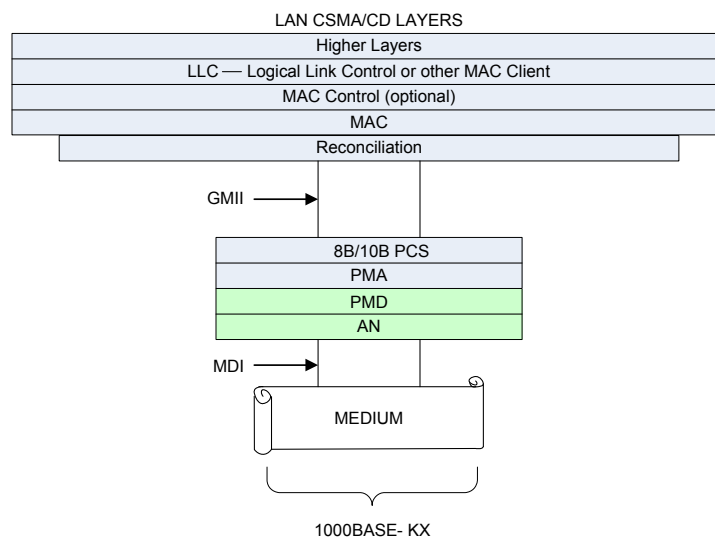


Figure 3-18 Architectural Positioning of 1000BASE-KX

3.7.2.1.2 KX Electrical Characteristics

The KX lane is a low swing AC coupled differential interface using NRZ signaling. AC coupling allows for inter-operability between components operating from at different supply voltages. Low swing differential signaling provides noise immunity and improved reduced electromagnetic interference (EMI). Differential signal swings defined specifications depend on several factors, such as transmitter pre-equalization and transmission line losses.

The KX signal paths are point-to-point connections. Each path corresponds to a KX lane and is comprised of two complementary signals making a balanced differential pair. There is one differential path in each direction for a total of two pairs, or four connections. The signal paths are intended to operate up to approximately one meter over controlled impedance traces on improved FR4 PCBs.



3.7.2.2 1000BASE-BX Operating Mode

1000BASE-BX is the PICMG 3.1 electrical specification for transmission of 1 Gb/s Ethernet encoded data over a 100 Ω differential backplane. The 1000BASE-BX standard defines a full-duplex interface that uses a single serial differential link in each direction (one pair for receive and one for transmit) to achieve 1 Gb/s data throughput. Each serial link operates at 1.25 GBaud to accommodate both data and the overhead associated with 8B/10B coding. The self-clocked nature eliminates skew concerns between clock and data. BX operating mode can be forced by software by setting the relevant bits in the AUTOC register and disabling auto-negotiation (see [Section 3.7.4.2](#)).

3.7.2.2.1 BX Electrical Characteristics

The BX lane is a low swing AC coupled differential interface. AC coupling allows for interoperability between components operating from at different supply voltages. Low swing differential signaling provides noise immunity and improved reduced EMI. Differential signal swings defined specifications depend on several factors, such as transmitter pre-equalization and transmission line losses.

The BX signal paths are point-to-point connections. Each path corresponds to a BX lane and is comprised of two complementary signals making a balanced differential pair. There is one differential path in each direction for a total of two pairs, or four connections.

3.7.3 SGMII Support

The 82599 supports 1 Gb/s and 100 Mb/s operation using the SGMII protocol over the KX and BX electrical interface (AC coupling, no source synchronous TX clock, etc.).

3.7.3.1 SGMII Overview

SGMII interface supported by the 82599 enables operation at 1 Gb/s over two differential, controlled impedance pairs of traces (one pair for transmit, one pair for receive). When operating in SGMII, the MAUI interface uses the 1000BASE-X PCS and PMA as defined in IEEE802.3 Clause 36 and the 1000BASE-KX PMD as defined in IEEE802.3ap Clause 70 or the 1000BASE-BX as defined in the PCIMG 3.1 standard. In SGMII operating mode, the MAUI interface can support data rates of 1 Gb/s and 100 Mb/s.

SGMII, supported by the 82599, is a full-duplex interface that uses a single serial differential link in each direction to achieve 1 Gb/s data throughput. Each serial link operates at 1.25 GBaud to accommodate both data and the overhead associated with 8B/10B coding. The self-clocked nature eliminates skew concerns between clock and data.

SGMII control information, as listed in [Table 3-17](#) is transferred from the PHY to the MAC to signal change of link speed (100 Mb/s or 1 Gb/s). This is achieved by using the auto-negotiation functionality defined in Clause 37 of the IEEE Specification 802.3z. Instead of the ability advertisement, the PHY sends the control information via its tx_config_reg[15:0] as listed in [Table 3-17](#) each time the link speed information changes. Upon receiving control information, the MAC acknowledges the update of the control information by asserting bit 14 of its tx_config_reg[15:0] as listed in [Table 3-17](#).



Compared to the definition in IEEE802.3 clause 37, the link_timer inside the auto-negotiation has been changed from 10 ms to 1.6 ms to ensure a prompt update of the link status.

Table 3-17 SGMII Link Control Information

Bit Number	TX_CONFIG_REG[15:0] Sent From PHY to MAC	TX_CONFIG_REG[15:0] Sent From MAC to PHY
15	Link: 0b = Link down 1b = Link up	0b = Reserved for future use.
14	Reserved for auto-negotiation acknowledge as specified in 802.3z	1b
13	0b: Reserved for future use	0b = Reserved for future use.
12	Duplex mode: 1b = full duplex, 0b = half duplex	0b = Reserved for future use.
11:10	Speed: Bit 11, 10: 11b = Reserved. 10b = 1000 Mb/s: 1000BASE-TX. 01b = 100 Mb/s: 100BASE-TX. 00b = 10 Mb/s: 10BASE-T (not supported).	00b = Reserved for future use.
9:1	0x0 = Reserved for future use.	0x0 = Reserved for future use.
0	1b	1b

When operating in 100 Mb/s the SGMII interface elongates the frame by replicating each frame byte 10 times for 100 Mb/s. This frame elongation takes place above the 802.3z PCS layer, thus the start frame delimiter only appears once per frame. Note that the 802.3z PCS layer might remove the first byte of the elongated frame. An example of a 100 Mb/s elongated frame can be seen in [Figure 3-19](#).

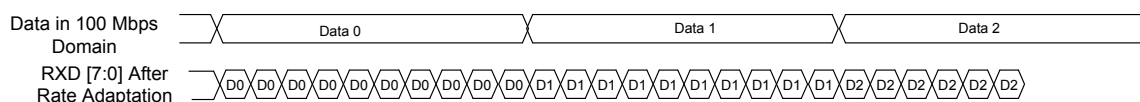


Figure 3-19 Data Sampling in 100 Mb/s Mode



3.7.4 Auto Negotiation For Backplane Ethernet and Link Setup Features

Auto-negotiation provides a linked device with the capability to detect the abilities (modes of operation) supported by the device at the other end of the link, determine common abilities, and configure for joint operation.

Auto-negotiation for backplane Ethernet is based on IEEE802.3 clause 28 definition of auto-negotiation for twisted-pair link segments. Auto-negotiation for backplane Ethernet uses an extended base page and next page format and modifies the timers to allow rapid convergence. Furthermore, auto-negotiation does not use Fast Link Pulses (FLPs) for link code word signaling and instead uses Differential Manchester Encoding (DME) signaling, which is more suitable for electrical backplanes. Since DME provides a DC balanced signal.

Auto-negotiation for backplane Ethernet is defined in IEEE802.3ap Clause 73 and includes support for parallel detection of 1000BASE-KX and 10GBASE-KX4 links in addition to transmission and reception of extended base page and next page auto-negotiation frames. The 82599 supports reception of extended base page and next page auto-negotiation frames but does not transmit next page auto-negotiation frames only NULL frames.

3.7.4.1 Link Configuration

The 82599 network interface meets industry specifications for:

- 10 GbE:
 - XAUI (IEEE 802.3ae)
 - SFI (SFF-8431 Specifications for Enhanced 8.5 and 10 Gigabit Small Form Factor Pluggable Module SFP+)
- 10 GbE — 10GBASE-CX4 (IEEE 802.3ak)
- 1 GbE backplane:
 - Ethernet 1000BASE-KX (IEEE 802.3ap)
 - Ethernet 1000BASE-BX (PICMG3.1)
 - SFI (SFF-8431 Specifications for Enhanced 8.5 and 10 Gigabit Small Form Factor Pluggable Module SFP+)
- 10 GbE backplane:
 - Ethernet 10GBASE-KX4 (IEEE 802.3ap)
 - Ethernet 10GBASE-KR (IEEE 802.3ap)

The MAUI AFE is configured at start up to support the appropriate protocol as a function of the negotiation process and pre-defined control bits that are either loaded from the EEPROM or configured by software.



3.7.4.2 MAC Link Setup and Auto Negotiation

The MAC block in the 82599 supports both 10 GbE and 1 GbE link modes and the appropriate functionality specified in the standards for these link modes.

Each of these link modes can use different PMD sub-layer and base band medium types.

In 10 GbE operating mode, the 82599 supports 10GBase-KX4, 10GBase-CX4, 10GBase-KR, SFI or XAUI (10 GbE Attachment Unit Interface). While in 1 GbE operating mode, the 82599 supports 1000Base-KX, 1000Base-BX or SGMII (SGMII also supports both 100 Mb/s and 1 Gb/s data rates) protocols. The different protocols supported in 10 GbE operating mode and 1 GbE operating mode affect only the configuration of the MAUI AFE and MAUI PHY logic blocks (PCS, FEC, etc.) while the MAC supports rates of either 1 Gb/s or 10 Gb/s, without need to know the electrical medium actually being interfaced.

Link speed and link characteristics can be determined through static configuration, parallel detect and auto-negotiation or forced operation for diagnostic purposes. The auto-negotiation processes defined in IEEE802.3ap clause 73 enables selection between KR (10G), KX4 (10G) and KX (1G) compliant link partners and defining link characteristics and link speed. While the auto-negotiation process defined in IEEE802.3 clause 37 enables detection of the BX (1 GbE) link characteristics but not the link speed.

Link setting is done by configuring the speed configuration in the AUTOC.LMS field, defining the appropriate physical interface by programming AUTOC.1G_PMA_PMD, AUTOC.10G_PMA_PMD_PARALLEL and AUTOC2.10G_PMA_PMD_Serial and restarting auto-negotiation by setting AUTOC.Restart_AN to 1b.

Note: Auto-negotiation logic will reset the data pipeline on AUTOC.Restart_AN assertion only if AUTOC.LMS field is changed. If the user wants to change link configuration parameters but keep the same AUTOC.LMS field value, link configuration must take these steps:

1. Read AUTOC register. Write back AUTOC register content with LMS[2] bit inverted (AUTOC bit 15) and Restart_AN bit asserted.
2. Read ANAS field in ANLP1 register. Check that it is not zero (or idle), indicating that autonegotiation was restarted.
3. Write AUTOC register with original LMS field and Restart_AN bit asserted.

3.7.4.3 Hardware Detection of Legacy Link Partner (Parallel Detection)

The 82599 supports the IEEE802.3ap clause 73 parallel detection process to enable a connection to legacy link partners that do not support auto-negotiation. Parallel detection enables detecting the link partner operating mode (KX4 or KX as defined in IEEE802.3ap clause 73) by activating KX4 and KX alternately and attempting to achieve link synchronization by the related PCS block.

Parallel detection is enabled as part of clause 73 backplane auto-negotiation process by appropriately configuring the link speed and auto-negotiation mode in the AUTOC.LMS register field, clearing AUTOC2.PDD to 0b and restarting auto-negotiation by setting the AUTOC.Restart_AN bit to 1b.



3.7.4.4 MAUI Link Setup Flow

The 82599 MAUI interface is configured at start up (before the driver is loaded) in the following manner:

1. If the link is statically configured by programming the appropriate AUTOC (LMS, 1G_PMA_PMD, 10G_PMA_PMD_PARALLEL) register fields and AUTOC2.10G_PMA_PMD_Serial field, the 82599 attempts to synchronize on incoming data and if successful updates the relevant Link status registers (LINKS, ANLP1 and ANLP2) and sets up the link. If link synchronization is not successful, the 82599 does not report link-up in the LINKS register and continuously attempts to set up the link according to the static configuration.
2. If the Link is not statically configured and parallel detection is enabled (auto-negotiation enabled in AUTOC.LMS and the AUTOC2.PDD parallel detect disable is 0b) the 82599 starts IEEE802.3ap clause 73 negotiation protocol by attempting to parallel detect the protocol on the MAUI interface by enabling KX and KX4 receive circuitry and trying to synchronize on incoming data. If synchronization succeeds in either KX or KX4 modes, the 82599 updates the relevant link status registers (LINKS, ANLP1 and ANLP2) and commences with setting up the link.
3. If parallel detect fails, the 82599 attempts to auto-negotiate according to IEEE802.3ap clause 73 using the data written to the AUTOC, AUTOC2 and AUTOC3 registers. If auto-negotiation succeeds, the 82599 updates the link status registers (LINKS, ANLP1 and ANLP2). If auto-negotiation fails, the 82599 does not report link up in the LINKS register and retries acquiring the link by parallel detection and auto-negotiation continuously (the receiver goes through a continuous cycle of 1 GbE parallel detect, 10 GbE parallel detect and clause 73 auto-negotiation).
4. If parallel detect or static configuration succeeds and the link rate is 1 Gb/s, AUTOC.LMS enables IEEE802.3 clause 37 auto-negotiation. The 82599 auto-negotiates to define link characteristics according to IEEE802.3 clause 37 using information placed in registers PCS1GANA and PCS1GANNP. On completion of clause 37 auto-negotiation, the 82599 updates the status in the LINKS, PCS1GLSTA, PCS1GANLNP and PCS1GANLP registers.
5. If parallel detect or static configuration succeeds and the link rate is 1 Gb/s, SGMII is enabled in the AUTOC.LMS field (LMS = 101b). If the 82599 detects the SGMII negotiation control information sent by the PHY, the 82599 auto-negotiates to define link characteristics (1 Gb/s or 100 Mb/s and full duplex capability) according to the SGMII specification. On completing SGMII auto-negotiation, the 82599 updates the status in the LINKS, PCS1GLSTA and PCS1GANLP registers.

When AUTOC.LMS is set to 1b of the auto-negotiation modes and the *Link Up* bit is set to 1b in the LINKS register, the final link speed can be read from the LINK_SPEED field of LINKS.

If LINK_SPEED is 10 Gb/s, the MLINK_MODE field is used to differentiate between KX4 (10 GbE parallel) and KR (10 GbE serial).

Note: AUTOC.AN_RESTART must be set on every AUTOC.LMS change.



3.7.4.5 Next Page Support

Next Page (NP) support in the 82599 is compliant with IEEE802.3ap.

The 82599 acts as receiver of NP each time the link partner needs to transmit NP data through the KX/KX4 auto-negotiation process.

The 82599 does not support transmission of configurable NP. It transmits a null NP each time the auto-negotiation arbitration state machine is required to go through the NP handshake. There is a possibility to configure the *Acknowledge2* field in the NP through the AUTOC.ANACK2 bit.

3.7.4.6 Forcing Link Up

Forcing link up can be accomplished by software by setting the AUTOC.FLU bit to 1b, which forces the MAC to the appropriate MAC link speed as defined by the AUTOC.LMS field and the appropriate protocol as defined by the AUTOC.10G_PMA_PMD_PARALLEL, AUTOC2.10G_PMA_PMD_Serial and AUTOC.1G_PMA_PMD bits. The Force-Link-Up mode enables loopback operation (when HLREG0.LPBK is set to 1b) by setting the link_up indication regardless of the XGXS/PCS_1G/KR_locked status. Link indication in register LINKS should be ignored when in this mode.

3.7.4.7 Crossover

The 82599 supports crossover on each of the two MAUI ports to eliminate the need for crossover cables between similar devices. This has historically been accomplished using special crossover cables (patch cables), magnetic pinouts or PCB wiring. The 82599 supports crossover configuration in both 10 GbE and 1 GbE operating modes via the SERDESC register.

Having established that there is a problem with the link connection, the driver detects and corrects crossovers and arbitrary polarity swaps for several configurations of pair swaps. Crossover can also be set by EEPROM following power up.

The following receiver pairs:

A — MI_QL0 (MIP_QL0 and MIN_QL0)

B — MI_QL1 (MIP_QL1 and MIN_QL1)

C — MI_QL2 (MIP_QL2 and MIN_QL2)

D — MI_QL3 (MIP_QL3 and MIN_QL3)

can be connected to the corresponding link partner's transmit pairs in any of the following ways with arbitrary polarity (positive and negative wires exchanged):

- No crossover
- A/B crossover only
- C/D crossover only
- A/B crossover and C/D crossover



Crossover operation is controlled by programming the relevant bits in the SerDes Interface Control (SERDESC) register. The SERDESC register supports correction of all combinations of crossover scenarios, in addition to the scenarios previously described.

3.7.5 Transceiver Module Support

The 82599 MAUI interface with additional usage of low speed interface pins (SDP, I²C and MDIO I/Os) supports a connection to transceiver modules compliant with the following Multi Source Agreements (MSAs):

- XENPAK — A cooperation agreement for 10 Gigabit Ethernet Transceiver package Rev 3.0
- X2 — A cooperation agreement for a small Versatile 10 Gigabit Ethernet Transceiver package Rev 2.0b
- XPAK — A cooperation agreement for a small form factor pluggable 10 Gigabit Ethernet Transceiver package Rev 2.2
- SFP+ — SFF-8431 Specifications for Enhanced 8.5 and 10 Gigabit Small Form Factor Pluggable Module SFP+ rev 1.0

Figure 3-20 shows the various transceiver module architecture.

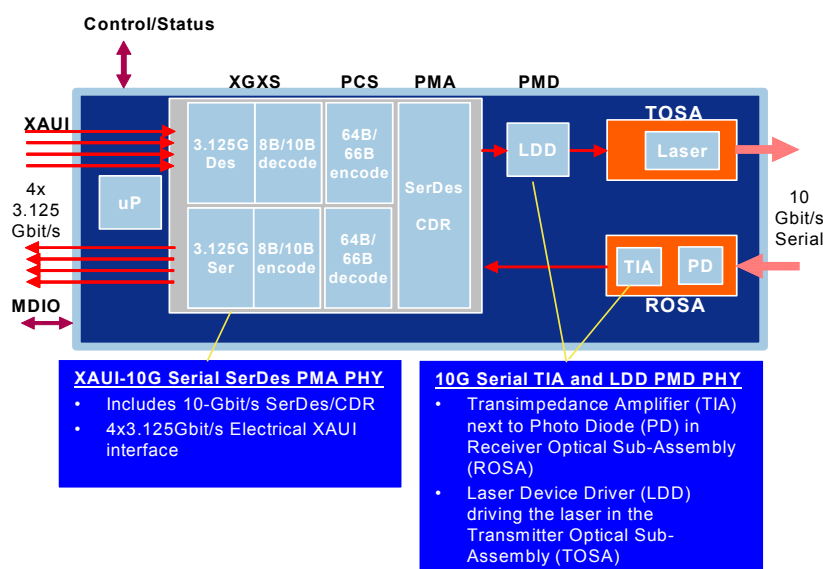


Figure 3-20 XENPAK, XPAK and X2 Transceiver Architecture

Table 3-18 lists the required interface (per port) for supporting the various modules. The 82599 supports the high speed interface using the MAUI port and the low speed interface using the SDP pins.



Table 3-18 Optical Module Interface Support

Module Type	High Speed MAUI Protocol	Low Speed Interface (per port)
XENPAK	XAUI	MDC ¹ (1.2V OUT), MDIO ¹ (1.2V I/O), TX ON/OFF ² (1.2V OUT), RESET ² (1.2V OUT) LASI (1.2V IN — Interrupt)
X2	XAUI	MDC ¹ (1.2V OUT), MDIO ¹ (1.2V I/O), TX ON/OFF ² (1.2V OUT), RESET ² (1.2V OUT) LASI (1.2V IN — Interrupt)
XPAK	XAUI	MDC ¹ (1.2V OUT), MDIO ¹ (1.2V I/O), TX ON/OFF ² (1.2V OUT), RESET ² (1.2V OUT) LASI (1.2V IN — Interrupt)
SFP+	SFI	SCL ¹ (I2C — OD), SDL ¹ (I2C — OD) TX Disable ³ (LVTTL — OUT), RS0/1 (LVTTL — OUT) TX Fault (LVTTL IN), RX_LOS (LVTTL — IN)

1. Single management interface can be used for two ports.

2. Output low during reset and power down.

The 82599 enables interfacing optical modules using the MAUI pins, MDIO pins, I²C pins and SDP pins. When interfacing with XENPAK, XPAK and X2 modules, level translators from LVTTL to 1.2V need to be added on the MDIO pins and the relevant SDP pins.

3.7.6 Management Data Input/Output (MDIO) Interface

The 82599 supports a MDIO interface (per port) to control PHY functionality through the interface. PHY configuration registers are mapped into the MDIO space and can be accessed by the MAC or any other MDIO-master device.

The 82599 supports the MDIO interface for a control plane connection between the MAC (master side) and PHY devices. The MDIO interface enables both MAC and software access to the PHY for monitor and control of PHY functionality. The 82599 is compliant with the IEEE802.3 clause 45 in both 10 GbE and 1 GbE operation. The 82599 also supports IEEE 802.3 clause 22 frame formats and register address space for accessing legacy PHY registers. The MDIO interface uses LVTTL signaling as defined in Clause 22 of the IEEE802.3 standard. To access PHYs that support clause 45 1.2V electrical interface, level translators need to be added on board.

Figure 3-21 shows the basic connectivity between the PHY and MAC.